L Number	Hits	Search Text	DB	Time stamp
1	18		USPAT;	2004/04/04 13:53
-		or ("6448638") or ("6446874") or	US-PGPUB;	
		("6132799") or ("6468835") or ("5671525")	EPO; JPO;	
		or ("5598032")).PN.	DERWENT;	
			IBM_TDB	
2	7	5850690.URPN.	USPAT	2004/04/04 13:18
3	1	(micro\$1module or module) same (metal\$9	USPAT;	2004/04/04 14:10
		near10 grid) same film same deform\$3	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
4	96	(micro\$1module or module) and (metal\$9	USPAT;	2004/04/04 13:56
1		near10 grid) and film and deform\$3	US-PGPUB;	
	•		EPO; JPO;	
			DERWENT;	
			IBM_TDB	
5	44	((micro\$1module or module) and (metal\$9	USPAT;	2004/04/04 14:12
		near10 grid) and film and deform\$3) and	US-PGPUB;	
		(cu or copper or ni or nickel or au or	EPO; JPO;	
		gold) and (printing or offset or inkjet) and (reel or line)	DERWENT; IBM TDB	
6	44	I	USPAT;	2004/04/04 14:07
~		near10 grid) and film and deform\$3) and	US-PGPUB;	=====================================
		(cu or copper or ni or nickel or au or	EPO; JPO;	
		gold) and (printing or offset or inkjet)	DERWENT;	
		and (reel or line)) and deposit\$3	IBM_TDB	
7	3	((((micro\$1module or module) and (metal\$9	USPAT;	2004/04/04 14:08
]		near10 grid) and film and deform\$3) and	US-PGPUB;	
		(cu or copper or ni or nickel or au or	EPO; JPO;	
		gold) and (printing or offset or inkjet)	DERWENT;	
		and (reel or line)) and deposit\$3) and card	IBM_TDB	
8	50	(micro\$1module or module or ic or chip)	USPAT;	2004/04/04 14:28
		same (metal\$9 near10 grid) same (card or	US-PGPUB;	
İ		medi\$2)	EPO; JPO;	
			DERWENT;	
l _	_		IBM_TDB	
9	7	((micro\$1module or module or ic or chip)	USPAT;	2004/04/04 14:29
		same (metal\$9 near10 grid) same (card or	US-PGPUB;	
		medi\$2)) and (cu or copper or ni or nickel or au or gold) and (printing or offset or	EPO; JPO; DERWENT;	
		inkjet) and (reel or line)	IBM TDB	
12	4		USPAT;	2004/04/04 14:15
		same (metal\$9 near10 grid) same (card or	US-PGPUB;	
		medi\$2)) and (cu or copper or ni or nickel	EPO; JPO;	
		or au or gold) and (printing or offset or	DERWENT;	
		inkjet or tracing) and (reel or line)) and	IBM_TDB	
10	7	deposit\$3 ((micro\$1module or module or ic or chip)	USPAT;	2004/04/04 14:25
1	·	same (metal\$9 near10 grid) same (card or	US-PGPUB;	2007/07/04 14.25
		medi\$2)) and (cu or copper or ni or nickel	EPO; JPO;	
		or au or gold) and (printing or offset or	DERWENT;	
		inkjet or tracing) and (reel or line)	IBM_TDB	
13	129530	(micro\$1module or module or ic or chip)	USPĀT;	2004/04/04 14:28
		same (card or medium)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
14	84841	(micro\$1module or module or ic or chip)	IBM_TDB USPAT;	2004/04/04 14:28
13	04041	same card	US-PGPUB;	2004/04/04 14:28
		525	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
15	170	((micro\$1module or module or ic or chip)	USPĀT;	2004/04/04 14:29
		same card) and (metal\$9 near30 grid)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
L			IBM TDB	

16	41	(((micro\$1module or module or ic or chip)	USPAT;	2004/04/04 14:29
		same card) and (metal\$9 near30 grid))	US-PGPUB;	
		and (cu or copper or ni or nickel or au or	EPO; JPO;	•
		gold) and (printing or offset or inkjet)	DERWENT;	
			IBM TDB	
18	37	((((micro\$1module or module or ic or chip)	USPĀT;	2004/04/04 15:17
		same card) and (metal\$9 near30 grid))	US-PGPUB;	
		and (cu or copper or ni or nickel or au or	EPO; JPO;	
		<pre>gold) and (printing or offset or inkjet))</pre>	DERWENT;	
		and deposit\$3	IBM TDB	
17	15	((((micro\$1module or module or ic or chip)	USPĀT;	2004/04/04 15:16
		same card) and (metal\$9 near30 grid))	US-PGPUB;	
		and (cu or copper or ni or nickel or au or	EPO; JPO;	
		gold) and (printing or offset or inkjet))	DERWENT;	
		and deform\$5	IBM TDB	
19	2212	235/492.ccls.	USPĀT;	2004/04/04 16:35
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
20	23	(((((micro\$1module or module or ic or	USPAT;	2004/04/04 15:17
		chip) same card) and (metal\$9 near30	US-PGPUB;	
		grid)) and (cu or copper or ni or nickel	EPO; JPO;	
		or au or gold) and (printing or offset or	DERWENT;	
		inkjet)) and deposit\$3) not	IBM_TDB	
		(((((micro\$1module or module or ic or		
		chip) same card) and (metal\$9 near30		
		grid)) and (cu or copper or ni or nickel		
		or au or gold) and (printing or offset or		
		inkjet)) and deform\$5)		
21	27		USPAT;	2004/04/04 15:23
		chip or module)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	İ
	_	(4865606000)	IBM_TDB	0004/04/04 45 55
22	9	(, ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	USPAT;	2004/04/04 16:02
		or ("5057679")).PN.	US-PGPUB;	
		·	EPO; JPO;	
· ·			DERWENT;	
		5057670 HPPN	IBM_TDB	0004/04/04 15 55
24 25		5057679.URPN.	USPAT	2004/04/04 16:16
23	471	235/488.ccls.	USPAT;	2004/04/04 16:35
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	